

# **GBU8A - GBU8M**

### **Features**

- Glass passivated junction.
- Surge overload rating: 200 amperes peak.
- Reliable low cost construction utilizing molded plastic technique.
- Ideal for printed circuit board.



# **Bridge Rectifiers**

### Absolute Maximum Ratings\* $T_A = 25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Value						Units	
		8A	8B	8D	8G	8J	8K	8M	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
V <sub>R</sub>	DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Rectified Forward Current, @ $T_A = 100^{\circ}$ C 8.0 @ $T_A = 45^{\circ}$ C 6.0			A A					
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	200		А					
T <sub>stg</sub>	Storage Temperature Range -55 to +150			°C					
TJ	Operating Junction Temperature -55 to +150			°C					

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	16	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,* per leg	18	°C/W

<sup>\*</sup>Device mounted on PCB with 0.5 x 0.5" (12 x 12 mm).

## **Electrical Characteristics** T<sub>A</sub> = 25°C unless otherwise noted

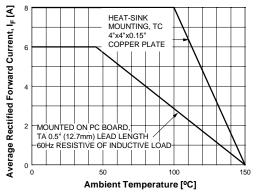
Symbol	Parameter	Device	Units
$V_{F}$	Forward Voltage, per element @ 8.0 A	1.0	V
I <sub>R</sub>	Reverse Current, per element @ rated $V_R$ $T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$	5.0 500	μΑ μΑ
	I <sup>2</sup> t rating for fusing t < 8.35 ms	166	A <sup>2</sup> s

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### **Bridge Rectifiers**

(continued)

## **Typical Characteristics**



**Figure 1. Forward Current Derating Curve** 

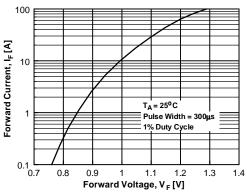


Figure 2. Forward Voltage Characteristics

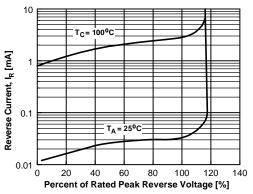


Figure 3. Reverse Current vs Reverse Voltage

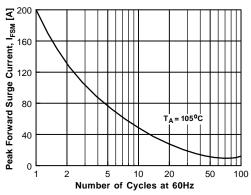


Figure 4. Non-Repetitive Surge Current

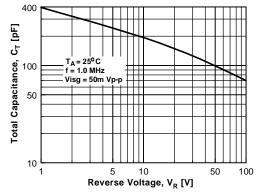


Figure 5. Total Capacitance

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